

The OPA855EVM is an evaluation module for the single OPA855 in the DSG (8-pin WSON) package.

The OPA855EVM is designed to quickly demonstrate the functionality and versatility of the amplifier. The EVM is ready to connect to power, signal source, and test instruments by using on-board connectors. The default amplifier configuration is a noninverting gain of 7 configuration and split-supply operation. The EVM can be easily configured for other gains and single-supply operation.

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## **Trademarks**

## 1 Features

- · Configured for split-supply operation and modified for single-supply operation
- Default noninverting gain of 7 configuration is reconfigurable for other gains
- Designed for connection to standard 50-Ω impedance test equipment
- Inputs and outputs include SMA connectors

## 2 EVM Specifications

This section provides a general description of the OPA855EVM. Table 1 lists limits for the EVM input and output.

**Table 1. EVM Input and Output Limits** 

| PARAMETER  | MIN       | TYP | MAX        | UNIT |
|--|-----------|-----|------------|------|
| Single–supply voltage range (VEE = ground)             | 3.2       |     | 5.2        | V    |
| Split–supply voltage range (VCC – VEE)                 | ±1.6      |     | ±2.6       | V    |
| Supply current, I <sub>S</sub>                         |           | 19  |            | mA   |
| Input voltage, V <sub>I</sub>                          | VEE + 0.2 |     | VCC - 1.25 | V    |
| Output drive, I <sub>O</sub> with ±2.5–V or 5–V supply |           | ±30 |            | mA   |



**EVM Specifications** www.ti.com

#### 2.1 **Power Connections**

The OPA855EVM is equipped with banana jacks for easy connection of power. The positive supply input is labeled VCC, the negative supply input is labeled VEE, and ground is labeled GND.

#### 2.1.1 **Split-Supply Operation**

To operate in split-supply operation, apply the positive supply voltage to VCC, the negative supply voltage to VEE, and the ground reference from supply to GND.

#### 2.1.2 Single-Supply Operation

To operate in single-supply operation, apply a jumper from VEE to GND and from the positive supply voltage to VCC. Inputs and outputs must be biased per data sheet specifications for proper operation.

### 2.2 Input and Output Connections

The OPA855EVM is equipped with SMA connectors to connect to signal generators and analysis equipment. As shipped, the EVM is configured for a noninverting gain of 7 configuration and split-supply operation with termination for connection to  $50-\Omega$  test equipment. For best results, signals must be routed to and from the EVM with cables with a characteristic impedance of 50  $\Omega$ . See the OPA855 data sheet, schematics, and layouts for details on how to reconfigure for other gain configurations.

#### 3 EVM Schematic, Layout, and Bill of Materials (BOM)

This section provides a complete schematic diagram, board layouts, and bill of materials for the OPA855EVM.

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## 3.1 EVM Schematic

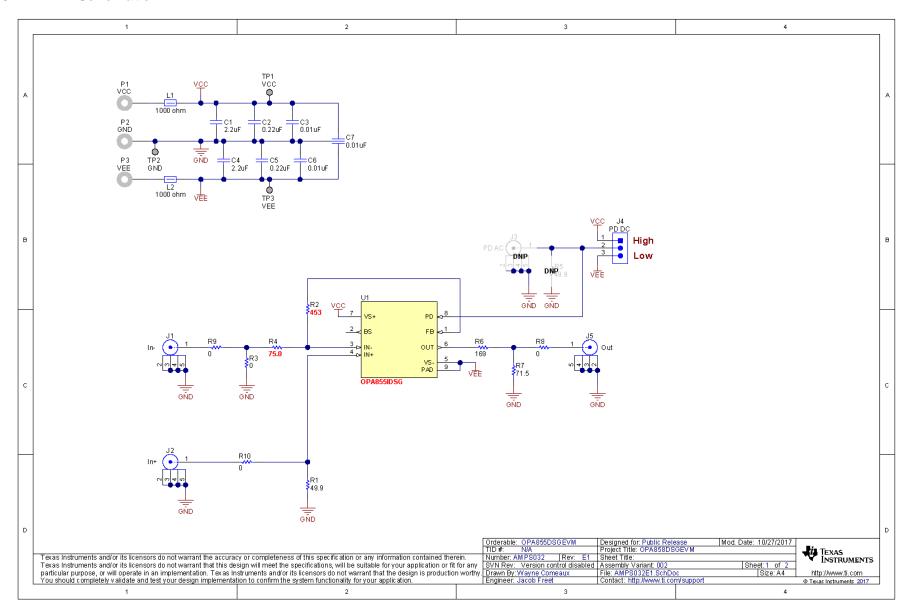


Figure 1. OPA855 and OPA855EVM Schematic



### 3.2 **EVM Layers**

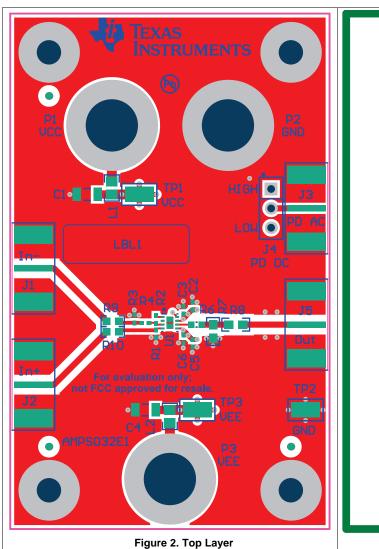
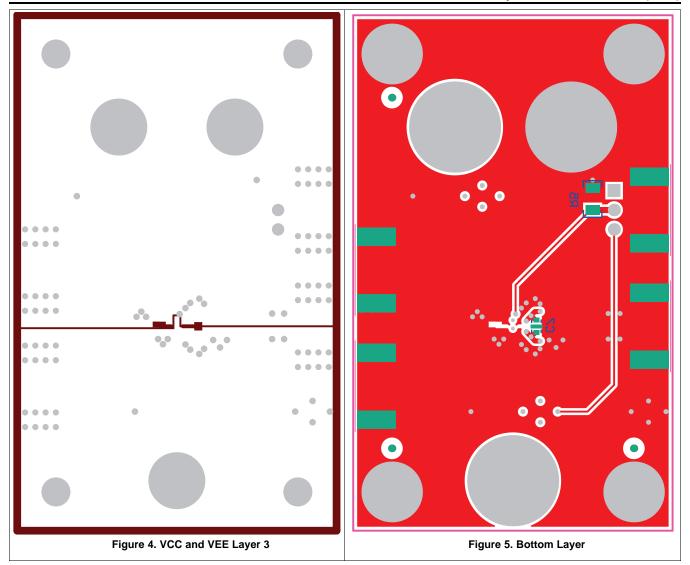


Figure 3. Ground Layer 2







# 3.3 Bill of Materials

# Table 2. OPA855EVM Bill of Materials

| ITEM | DESCRIPTION   | SMD SIZE                       | REFERENCE DESIGNATOR | PCB QUANTITY | PART NUMBER OF MANUFACTURER              |
|------|---|--------------------------------|----------------------|--------------|--|
| 1    | CAP, CERM, 2.2 uF, 25 V, +/- 10%, X7R                     | 1206                           | C1, C4               | 2            | (MuRata) GRM31MR71E225KA93L              |
| 2    | CAP, CERM, 0.22 uF, 25 V, +/- 20%, X5R                    | 0402                           | C2, C5               | 2            | (TDK) C1005X5R1E224M050BC                |
| 3    | CAP, CERM, 0.01 uF, 25 V, +/- 10%, X7R                    | 0402                           | C3, C6               | 2            | (MuRata) GRM155R71E103KA01D              |
| 4    | CAP, CERM, 0.01 uF, 50 V, +/- 20%, X7R                    | 0603                           | C7                   | 1            | (Johanson Technology)<br>500X14W103MV4T  |
| 5    | Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead | Screw                          | H1, H2, H3, H4       | 4            | (B&F Fastener Supply) NY PMS 440 0025 PH |
| 6    | Standoff, Hex, 0.5"L #4-40 Nylon                          | Standoff                       | H5, H6, H7, H8       | 4            | (Keystone) 1902C                         |
| 7    | Connector, End launch SMA, 50 ohm                         | SMA End Launch                 | J1, J2, J5           | 3            | (Cinch Connectivity) 142-0701-851        |
| 8    | Header, 100mil, 3x1, Gold, TH                             | 3x1 Header                     | J4                   | 1            | (Samtec) TSW-103-07-G-S                  |
| 9    | Ferrite Bead, 1000 ohm @ 100 MHz, 0.5 A                   | 0805                           | L1, L2               | 2            | (MuRata) BLM21AG102SN1D                  |
| 10   | Thermal Transfer Printable Labels, 0.650" W x 0.200" H    | PCB Label<br>0.650"H x 0.200"W | LBL1                 | 1            | (Brady) THT-14-423-10                    |
| 11   | Standard Banana Jack, Uninsulated                         | Keystone_6095                  | P1, P2, P3           | 3            | (Keystone) 6095                          |
| 12   | RES, 49.9, 1%, 0.063 W                                    | 0402                           | R1                   | 1            | (Vishay-Dale) CRCW040249R9FKED           |
| 13   | RES, 453, 1%, 0.063 W                                     | 0402                           | R2                   | 1            | (Vishay-Dale) CRCW0402453RFKED           |
| 14   | RES, 0, 5%, 0.063 W                                       | 0402                           | R3                   | 1            | (Vishay-Dale) CRCW04020000Z0ED           |
| 15   | RES, 75.0, 1%, 0.063 W                                    | 0402                           | R4                   | 1            | (Vishay-Dale) CRCW040275R0FKED           |
| 16   | RES, 169, 1%, 0.1 W                                       | 0603                           | R6                   | 1            | (Vishay-Dale) CRCW0603169RFKEA           |
| 17   | RES, 71.5, 1%, 0.1 W                                      | 0603                           | R7                   | 1            | (Vishay-Dale) CRCW060371R5FKEA           |
| 18   | RES, 0, 5%, 0.1 W   | 0603                           | R8, R9, R10          | 3            | (Vishay-Dale) CRCW06030000Z0EA           |
| 19   | Shunt, 100mil, Gold plated, Black                         |                                | SH-J1                | 1            | (AMP) 382811-6                           |
| 20   | Test Point, Miniature                                     | Test Point,<br>Miniature, SMT  | TP1, TP2, TP3        | 3            | (Keystone) 5019                          |
| 21   | IC, OPA855IDSG (WSON-8)                                   |                                | U1                   | 1            | (Texas Instruments) OPA855IDSGT          |
| 22   | Connector, End launch SMA, 50 ohm                         | SMA End Launch                 | J3                   | 0            | (Cinch Connectivity) 142-0701-851        |
| 23   | RES, 49.9, 1%, 0.25 W                                     | 1206                           | R5                   | 0            | (Vishay-Dale) CRCW120649R9FKEA           |

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